Applic	able stand	ard 🕂	UL : UL1977, C-UL : CSA2	22.2 No.1	82.3-M1	987, -	TÜV : El	N6198	4:2009 ⁽³⁾			
RATING	Voltage		600 V AC/DC		Operating Temperature Range			-55 °C to 105 °C $^{(1)}$				
					Н	Operating Humidity Range			Relative Humidity 85% max (Not dewed)			
	Current 🕂		25 A (AMBIENT TEPM 25°C) 18 A (UL/C-UL) 19 A (TÜV)			Storage Temperature Range -10 °C			-10 °C to 6	to 60 °C ⁽²⁾		
					Storage Humidity Range			40 % to 70	40 % to 70 % ⁽²⁾			
			SPEC	IFICA	TION	S						
ITE	EM	TEST METHOD				REQUIREMENTS					AT	
CONSTRUCTION												
General Examination		Visually and by measuring instrument.				According to drawing.					×	
Marking ELECTRIC CHARAC		Confirmed visually.									×	
						_						
Contact Resis		10 mA(DC or 1000Hz)				2 m Ω MAX.				×	-	
Insulation Resistance		1000 V DC.				1000 MΩ MIN.					-	
Voltage Proof		1800 V AC for 1 min. No flashover or breakdown.								×	-	
MECHANIC	CHAR						_			×	1	
Insertion and Withdrawal Forces		Measured by applicable connector.				Insertion Force: 10 N MAX. Withdrawal Force: 0.4 N MIN.					-	
Mechanical Operation		100 times insertions and extractions.				(1) Contact Resistance: 5 m Ω MAX.					-	
						② No damage, crack and looseness of parts.						
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.				 ① No electrical discontinuity of 1 μs. ② No damage, crack and looseness of parts. 						
Shock		490 m/s ² , duration of pulse 11 ms, 3 times to both directions in 3 axial directions.								×	1-	
ENVIRON				ections.								
Damp Heat			$at 40 \pm 2 \circ C, 90 \sim 95 \%,$	96 +4	h	① Cor	tact Re	sistan	ce:5mΩ MAX.	×	_	
(Steady State)					1.	 ② Insulation Resistance: 1000 MΩ MIN. ③ No damage, crack and looseness of parts. 						
Rapid Change of Temperature		Temperature $-55 \rightarrow +105 ^{\circ}\text{C}$ Time $30 \rightarrow 30 \text{min.}$ under 5 cycles. (Relocation time to chamber: within 2~3 MIN)				3 NU	uamaye	, clacr		×	_	
Dry heat		Exposed at +105±2°C for 96±4h.									-	
Cold		Exposed at -55±2°C for 96±4h.									-	
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96h±4h.				 Contact Resistance: 5m Ω MAX. No defect such as corrosion which impairs 					1-	
						the function of connector.						
Resistance to Soldering Heat		Solder bath : Solder temperature 260±5°C for immersion, duration 10±1sec. Soldering irons : 380°C MAX. for 10 sec.				No deformation of case of excessive looseness of the terminal.					-	
Solderability			ered at solder temperature $240\pm3^{\circ}$ C imersion, duration 3 sec.			A new uniform coating of solder shall cover a × - minimum of 95 % of the surface being immersed.						
COUNT D		ESCRIPTION OF REVISIONS DES			DESIC	IGNED			CHECKED	ח	ATE	
A 4					TS. 00N0		HT. YAMAGUCHI		12.16			
	Include tempera	ture rise caused by current-carrying.			10.00	13.0000		OVED	HS. OKAWA		14. 09. 12	
	⁾ "Storage" means	s a long-term	a long-term storage state roduct before assembly to PCB.					KED	KN. SHIBUYA		14. 09. 12	
(3)		e:2 type of terminals :dip solder contacts.						NED	DK. AIMOTO	14. 09. 11		
Unless otherwise specified, refer			to JIS-C-5402,IEC60512.					DRAWN DK. AIMOTO		14. 09. 11		
			ance Test X:Applicable Test		DF	DRAWIN						
HRS	SPECIFICATION SHEET				PART	PART NO. FX30		30B-2P-7. 62DSA3	3-2P-7. 62DSA30			
			ECTRIC CO., LTD.		CODE		<u> </u>		-3304-3-00	^	1/2	

FORM HD0011-2-1

